

Remarks

The specification at page 1 has been amended to identify the application of which this is a divisional.

At page 4, an inadvertent error in the number of the prior art patent disclosing a process for fabricating SMA material in thin film form has been corrected. This same amendment was made in the parent application of which this is a divisional.

The foregoing amendments do not introduce new matter; thus entry of the amendments are considered to be in order and such action is solicited.

Date: Sep 11, 2003



Richard E. Backus, Reg. 22,701
Attorney for Applicants

LAW OFFICES OF RICHARD E. BACKUS
685 MARKET STREET, SUITE 490
SAN FRANCISCO, CALIFORNIA 94105